TOSHIBA TLN113

TOSHIBA INFRARED LED GaAs INFRARED EMITTER

TLN113

INFRARED LED FOR PHOTO SENSOR

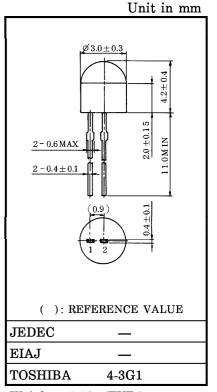
OPTO-ELECTRONIC SWITCH TAPE, CARD READERS **ROTARY ENCODER** DETECTION OF FDD (FLOPPY DISK DRIVE)

- High radiant intensity
- Best suited for combination with Photo Transistor TPS613.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current	$I_{\mathbf{F}}$	40	mA
Forward Current Derating (Ta>25°C)	$\Delta I_{\mathbf{F}}/^{\circ}\mathbf{C}$	-0.53	mA/°C
Pulse Forward Current (Note)	$I_{ extbf{FP}}$	400	mA
Reverse Voltage	$v_{ m R}$	5	V
Operating Temperature Range	${ m T_{opr}}$	-20~75	°C
Storage Temperature Range	${ m T_{stg}}$	-30~100	°C

(Note) Pulse Width $\leq 100 \mu s$, Repetitive Frequency = 100Hz



Weight: 0.08g (TYP.)

PIN CONNECTION

1 ○ → 2

1. ANODE 2. CATHODE

OPTO-ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Forward Voltage	$ m V_{ m F}$	$I_{\mathbf{F}} = 10 \text{mA}$	_	1.15	1.30	V
Reverse Current	$I_{ m R}$	$V_R = 5V$	_	_	10	μ A
Radiant Intensity (Note)	${ m I_E}$	$I_{ m F}\!=\!20{ m mA}$	0.8	_	4.8	mW/sr
Radiant Power	Po	$I_{ m F}\!=\!20{ m mA}$	_	2.5	_	mW
Capacitance	$\mathrm{c_{T}}$	$V_R = 0$, $f = 1MHz$	_	30		pF
Peak Emission Wavelength	$\lambda_{ extbf{P}}$	$I_{ extbf{F}} = 20 ext{mA}$	_	940		nm
Spectral Line Half Width	Δλ	$I_{ extbf{F}} = 20 ext{mA}$	_	50	_	nm
Half Value Angle	$\theta \frac{1}{2}$	$I_{\mathbf{F}} = 20 \text{mA}$	_	±40	_	0

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PRECAUTION

Please be careful of the followings.

Soldering temperature: 260°C MAX. Soldering time: 3s MAX. (Soldering portion of lead : above 2mm from the body of the device)

When the lead is formed, the lead shall be formed at a distance of 2mm from the body without leaving forming stress to the body of the device.

Soldering shall be performed after lead forming.

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Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

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